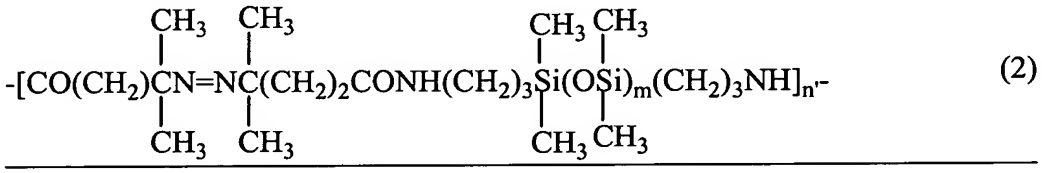
IN THE CLAIMS

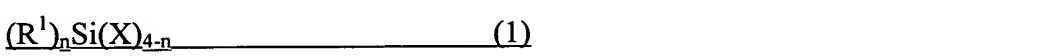
Please amend the claims as follows:

Claim 1 (Currently Amended): A polymer composition comprising (A) a polymer having a silicon atom bound to a hydrolytic group and/or a hydroxyl group, and which is obtained in the presence of a polymerization initiator having a recurring unit represented by the following general formula (2):



$$-[CO(CH_2)\overset{\overset{CH_3}{|}}{\underset{\underset{CH_3}{|}}{C}}N=N\overset{\overset{CH_3}{|}}{\underset{\underset{CH_3}{|}}{C}}(CH_2)_2CONH(CH_2)_3\overset{\overset{CH_3}{|}}{\underset{\underset{CH_3}{|}}{Si}}(O\overset{\overset{CH_3}{|}}{\underset{\underset{CH_3}{|}}{Si}})_m(CH_2)_3NH]_{n'}- \qquad (2)$$

wherein m is from 5 to 250, and n' is from 4 to 40; and (B) at least one component selected from the group consisting of an organosilane represented by the following general formula (1), a hydrolyzate of the organosilane and a condensate of the organosilane:



$$(R^1)_nSi(X)_{4-n} \qquad (1)$$

wherein, R^1, which maybe the same or different when two or more R^1 groups are present, represents a monovalent organic group having 1 to 8 carbon atoms; X represents a halogen atom or an alkoxyl or acetoxyl group having 1 to 8 carbon atoms; and n is an integer of 0 to 2; in which the maximum size of particles contained ~~therein~~ in said composition is 2 μm ~~or less~~, and the number of particles having a size of 0.2 μm to 2 μm in said composition is 1,000 particles/ml or less.

Claims 2-3 (Cancelled).

Claim 4 (Previously Presented): The polymer composition according to Claim 1, wherein the polystyrene-converted weight-average molecular weight of component (A) is from 1,000 to 100,000.

Claim 5 (Previously Presented): The polymer composition according to Claim 1, further comprising (C) a photoacid generating agent.

Claim 6 (Previously Presented): The polymer composition according to Claim 1, further comprising (D) a dehydrating agent.

Claim 7 (Previously Presented): A cured product obtained by coating a substrate with the polymer composition according to Claim 1, and subjecting the composition to heat curing and/or photo-curing.

Claim 8 (Previously Presented): The cured product according to Claim 7, wherein a surface of the substrate has an arithmetical mean roughness of 0.5 μm or less and/or a maximum height of projections thereon of 2 μm or less.

Claim 9 (Previously Presented): The cured product according to Claim 7, wherein the substrate is a film whose surface has an arithmetical mean roughness of 0.5 μm or less and/or a maximum height of projections thereon of 2 μm or less.

Claim 10 (Previously Presented): The cured product according to Claim 7, wherein a surface of the cured product has an arithmetical mean roughness of 0.2 μm or less and/or a maximum height of projections thereon of 2 μm or less.

Claim 11 (Previously Presented): The cured product according to Claim 7, wherein the surface of the cured product has a hydroxyl group concentration of 10% or less.

Claim 12 (Previously Presented): The cured product according to Claim 7, wherein the surface of the cured product has a coefficient of dynamic friction of 0.5 or less.

Claim 13 (Previously Presented): The cured product according to Claim 7, which has a release, non-adhesive function.

Claim 14 (Previously Presented): A laminate having the cured product composed of the polymer composition according to Claim 1 on a substrate film, in which a surface of the substrate has an arithmetical mean roughness of 0.5 μm or less and/or a maximum height of projections thereon of 2 μm or less and 1,000 projections/m^2 or less of projections having a height of 0.2 μm to 2 μm, and a surface of the cured product has an arithmetical mean roughness of 0.2 μm or less and/or a maximum height of projections thereon of 2 μm or less and 500 projections/m^2 or less of projections having a height of 0.2 μm to 2 μm.

Claim 15 (Previously Presented): A method for producing a cured product, which comprises coating a substrate with the polymer composition according to Claim 1, and subjecting the composition to heat curing and/or photo-curing.

DISCUSSION OF THE AMENDMENT

Claim 1 has been amended by incorporating the subject matter of Claims 2 and the subject matter disclosed in the specification at page 21, lines 7-11 (formula (2) is disclosed at page 4, lines 1-7) therein; Claims 2 and 3 have been cancelled. Claim 1 has also been amended by deleting the redundant "or less" with regard to the maximum particle size limitation.

No new matter is believed to have been added by the above amendment. Claims 1 and 4-15 are now pending in the application.